# □ MN103S83D

| Type<br>Internal ROM                  |       |    | MN103S83D<br>64K-byte  |  |  |  |
|---------------------------------------|-------|----|--|--|--|--|
|                                       |       |    |  |  |  |  |
| Internal RAM                          |       |    | 2K-byte  |  |  |  |
| Package                               |       |    | QFP084-P-1818E *Lead-free, LQFP080-P-1414A *Lead-free (under development)  |  |  |  |
| Minimum Instruction<br>Execution Time |       |    | 25 ns (at 4.3 V to 5.5 V, 10 MHz internal regulator used)<br>25 ns (at 3.0 V to 3.6 V, 10 MHz)<br>*at internal 4 times oscillation used)   |  |  |  |
| Interrupts                            |       |    | <ul> <li>9 external interrupts</li> <li>40 internal interrupts (watch dog timer, timer, serial I/F, PWM, A/D, system error)</li> </ul>   |  |  |  |
| Timer Counter                         |       |    | <ul> <li>8-bit timer × 8<br/>Timer 0 to 7: Interval timer, Event counter, Cascading connectable</li> <li>16-bit timer × 4<br/>Timer 8: Interval timer, Event counter, PWM output (6 pins simultaneous output are available), Double buff<br/>Timer 9, 10: Interval timer, Event counter, PWM output, Double buffer<br/>Timer 11: Interval timer, Double buffer, Start synchronized with 3-phase PWM are available</li> </ul> |  |  |  |
|                                       |       |    | Watch dog timer  |  |  |  |
| Serial Interfact                      | e     |    | UART (full duplex) / synchronous interfaces selective × 2<br>Serial 1: 7-bit, 8-bit transmission<br>Serial 2: 1-bit to 8-bit transmission (synchronous), 2 and 3 channel type selectable (synchronous)   |  |  |  |
| I/O Pins                              | I/O   | 50 | Exclusive $\times$ 5, selective $\times$ 45  |  |  |  |
|                                       | Input | 10 | Selective × 10   |  |  |  |
| A/D Inputs                            |       |    | 10-bit × 2 unit, 2 inputs × 2, 6 inputs × 1<br>Simultaneous conversion of 3 series are available, With S/H,<br>Conversion start synchronized with 3-phase PWM or timer 11 are available  |  |  |  |
| Motor Control PWM                     |       |    | 16-bit 3-phase PWM × 1<br>Minimum resolution: 50 ns<br>Triangular waveform or jigsaw waveform dead time setup,<br>Double buffer, Output polar switching is available, PWM output pin protect function  |  |  |  |
|                                       |       |    |  |  |  |  |

### Electrical Characteristics

#### A/D converter characteristics

| Parameter            | Symbol | Condition | Limit |     |     | Unit |
|----------------------|--------|-----------|-------|-----|-----|------|
| Falanielei           |        |           | min   | typ | max | Unit |
| Non-linear error     |        | 10-bit    |       |     | ±3  | LSB  |
| A/D conversion time  | tAD    |           | 1.5   |     |     | μs   |
| Analog input voltage | VIA    |           | VSS   |     | VDD | V    |

 $(Ta = 25^{\circ}C, VDD = 5.0 V, VSS = 0 V)$ 

#### Pin Assignment



QFP084-P-1818E \*Lead-free

LQFP080-P-1414A \*Lead-free (under development)

#### Support Tool

| In-circuit Emulator        | PX-ICE-103S65                      |   |  |  |
|----------------------------|------------------------------------|---|--|--|
| Flash Memory Built-in Type | Туре                               | MN103SF65GBF, MN103SF65GAL                                |  |  |
|                            | ROM                                | 128K-byte   |  |  |
|                            | RAM                                | 4K-byte   |  |  |
|                            | Minimum instruction execution time | 25 ns (at 4.3 V to 5.5 V, 10 MHz internal regulator used) |  |  |
|                            |                                    | 25 ns (at 3.0 V to 3.6 V, 10 MHz)                         |  |  |
|                            | Package                            | QFP084-P-1818I *Lead-free, LQFP080-P-1414B *Lead-free     |  |  |

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